

THE MONODIAM-HE PROJECT : MONOCRISTALLINE DIAMOND FOR HL-LHC PIXEL DETECTORS

J-M. BROM : IPHC @ STRASBOURG J. COLLOT - J-Y. HOSTACHY - J-F. MURAZ - M. YAMOUNI - A.PINGAULT : LPSC @ GRENOBLE

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INTRODUCTION

Particle Paths

A new 4-year R&D endeavor carried out by four French laboratories involved in LHC experiments and in material science is aiming at elaborating sizeable (1x1 cm²) monocrystalline diamonds that could be used in the inner most parts of the High-Luminosity LHC pixel detectors. Polycrystalline diamonds are already used in several collider experiments [1] thanks to their good capability to withstand high radiation doses. Monocrystalline diamond (*MCD*) sensors could feature enhanced detection properties and a more homogeneous response.

DIAMOND AS ADETECTION SENSOR

Outer Chip

Inner Chip

- One can compute the CCD vs the applied field
- $-$ CCD $>$ 400 µm

Summary of several properties of diamond and silicon

- Diamond interest : Radiation hardness

- Flaw : Lower Signal

TEST BENCH

- Low pressure $({\sim}0.1~{\rm bar})$ and T ${\sim}1000~{\rm K}$
- Small sized diamond (up to 5*x*5 mm²) [2]
- Need to cut off the seed from the substrate (Laser cut/acid bath)
- Induce surface defects=> need for polishing the surface

Particle Origin (Vertex) A vertex reconstruction Picture of a diamond sample top view Property **Diamond** Silicon Best **Density** $[g \text{ cm}^{-3}]$ 3.52 2.33
 Band Gap $[eV]$ 5.48 1.12 **Band Gap** [eV] $\begin{array}{ccc} 5.48 & 1.12 & / \\ 5.48 & 3.62 & \text{Silicon} \end{array}$ **Energy to create e-h pair[eV] Mean Signal** (MIP) $36 e^- / \mu m$ $89 e^- / \mu m$
 Resistivity [Ω cm] $10^{13} - 10^{16}$ $10^5 - 10^6$ **Resistivity** $[\Omega \text{cm}]$ **Thermal Conductivity** $[W \text{ cm}^{-1} K^{-1}]$ > 1800 1.48 **Displacement Energy**[eV] 43 25 Diamond **Electron mobility** $\text{[cm}^2 \text{ V}^{-1} \text{ s]}$ 1900 1450 **Hole mobility** $[\text{cm}^2 \text{ V}^{-1} \text{ s}]$ 2300 505
Breakdown Field $[\text{V cm}^{-1}]$ 10^7 $3 \cdot 10^5$ **Breakdown Field**[V cm^{-1}]

 CCD (μ m) = $\frac{Number\ of\ electrons\ collected}{36}$ 36

– Corresponds to $\sim 10\,000$ electrons – Yielding a comfortable S/N Ratio

- **Energy distribution in very thin material : Complicated to calculate**
	- Due to rare phenomena (fast emitted *δ*rays mainly)
	- Give the Landau its asymmetry.
- **Fitted curve :** Convolution of a Gaussian with a Landau

Analysis made for several bias voltage :

PROSPECTS AND CONCLUSION

A CCD value > **400** µm can be obtained ⇒ Very encouraging for the future ⇒ **Compatible with a HEP application**

Many things remain to be done:

- Production and tests of bigger diamonds of the same quality
- Mastering of surface preparation and metallization step
- Control of the radiation hardness of samples
- Pixelization
- Beam tests

REFERENCES

[1] ATLAS Collaboration, The ATLAS-IBL Project ATL-COM-INDET-2010-031, (2010) [2] F. Silva, K. Hassouni, X. Bonnin and A. Gicquel Microwave engineering of plasma-assisted CVD reactors for diamond deposition Journal of Physics: Condensed Matter 21, p. 364202, (2009)

CHARGE COLLECTION DISTANCE (CCD)

Mean distance of separation between electron-hole

- **Most important parameter** for a HEP use
- Limited by crystal defects

– **Approximated by :**

– A minimum of 300 µm is required :